National Semiconductor

DS90C031 LVDS Quad CMOS Differential Line Driver

General Description

The DS90C031 is a quad CMOS differential line driver designed for applications requiring ultra low power dissipation and high data rates. The device is designed to support data rates in excess of 155.5 Mbps (77.7 MHz) utilizing Low Voltage Differential Signaling (LVDS) technology.

The DS90C031 accepts TTL/CMOS input levels and translates them to low voltage (350 mV) differential output signals. In addition the driver supports a TRI-STATE® function that may be used to disable the output stage, disabling the load current, and thus dropping the device to an ultra low idle power state of 11 mW typical.

The DS90C031 and companion line receiver (DS90C032) provide a new alternative to high power psuedo-ECL devices for high speed point-to-point interface applications.

Connection Diagram

Features

- >155.5 Mbps (77.7 MHz) switching rates
- ± 350 mV differential signaling
- Ultra low power dissipation
- 400 ps maximum differential skew (5V, 25°C)
- 3.5 ns maximum propagation delay
- Industrial operating temperature range
- Available in surface mount packaging (SOIC)
- Pin compatible with DS26C31, MB571 (PECL) and 41LG (PECL)
- Compatible with IEEE 1596.3 SCI LVDS standard
- Compatible with proposed TIA LVDS standard







TL/F/11946-2

DRIVER Enables Input Outputs EN* DOUT-EN DIN DOUT+ L н х z z All other combinations L L н of ENABLE inputs н н L.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V _{CC})	-0.3V to +6V
Input Voltage (D _{IN})	-0.3V to (V _{CC} + 0.3V)
Enable Input Voltage (EN, EN*)	-0.3V to (V _{CC} + 0.3V)
Output Voltage (D _{OUT+} , D _{OUT-})	-0.3V to (V _{CC} + 0.3V)
Short Circuit Duration (DOUT+, DC	OUT-) Continuous
Maximum Package Power Dissipa	tion @ +25°C
M Package	1068 mW
Derate M Package	8.5 mW/°C above + 25°C

Storage Temperature Range	-65°C to +150°C
Lead Temperature Range Soldering (4 se	ec.) + 260°C
Maximum Junction Temperature	+ 150°C
ESD Rating (HBM, 1.5 k Ω , 100 pF)	≥3,500V (Note 7)

Recommended Operating Conditions

	Min	Тур	Max	Units
Supply Voltage (V _{CC})	+ 4.5	+ 5.0	+ 5.5	v
Operating Free Air				
Temperature (T _A)	-40	+ 25	+ 85	°C

Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified (Notes 2 and 3).

Symbol	Parameter	Conditions	Pin	Min	Тур	Max	Unita
V _{OD1}	Differential Output Voltage	R _L = 100Ω (<i>Figure 1</i>)		250	345	450	mV
ΔV _{OD1}	Change in Magnitude of V _{OD1} for Complementary Output States		D _{OUT} -,		4	35	mV
V _{OS}	Offset Voltage		D _{OUT+}	1.125	1.25	1.375	v
ΔV _{OS}	Change in Magnitude of V _{OS} for Complementary Output States				5	25	mV
V _{OH}	Output Voltage High	$R_L = 100\Omega$			1.41	1.60	v
V _{OL}	Output Voltage Low			0.90	1.07		v
VIH	Input Voltage High			2.0		Vcc	v
VIL	Input Voltage Low		D _{IN} , EN,	GND		0.8	v
կ	Input Current	$V_{IN} = V_{CC}$, GND, 2.5V, or 0.4V	EN, EN*	-10	±1	+ 10	μΑ
V _{CL}	Input Clamp Voltage	$I_{CL} = -18 \text{ mA}$		- 1.5	-0.8		v
los	Output Short Circuit Current	V _{OUT} = 0V (Note 8)	D		- 3.5	-5.0	mA
loz	Output TRI-STATE Current	EN = 0.8V and EN* = 2.0V, V_{OUT} = 0V or V_{CC}	D _{OUT-} , D _{OUT+}	-10	±1	+ 10	μΑ
lcc	No Load Supply Current	$D_{IN} = V_{CC} \text{ or } GND$			1.7	3.0	mA
	Drivers Enabled	D _{IN} = 2.5V or 0.4V			4.0	6 .5	mA
ICCL	Loaded Supply Current Drivers Enabled	$R_L = 100\Omega$ All Channels $V_{IN} = V_{CC}$ or GND (all inputs)	Vcc		15.4	21.0	mA
I _{CCZ}	No Load Supply Current Drivers Disabled	$D_{IN} = V_{CC} \text{ or GND}$ EN = GND, EN* = V _{CC}			2.2	4.0	mA

Switching Characteristics $V_{CC} = +5.0V, T_A = +25^{\circ}C$ (Notes 3, 4, 6, 9)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
^t PHLD	Differential Propagation Delay High to Low	$R_L = 100\Omega$, $C_L = 5 pF$ (<i>Figures 2</i> and <i>3</i>)	1.0	2.0	3.0	ns
^t PLHD	Differential Propagation Delay Low to High		1.0	2.1	3.0	ns
tskd tphld-tplhd	Differential Skew		0	80	400	ps
tsk1	Channel to Channel Skew	Note 4	0	300	600	ps
^t TLH	Rise Time	$R_L = 100\Omega, C_L = 5 pF$		0.35	1.5	ns
t⊤HL	Fall Time	(Figures 2 and 3)		0.35	1.5	ns
t _{PHZ}	Disable Time High to Z	(<i>Figures 4</i> and <i>5</i>)		2.5	10	ns
t _{PLZ}	Disable Time Low to Z			2.5	10	ns
t _{PZH}	Enable Time Z to High			2.5	10	ns
tPZL	Enable Time Z to Low			2.5	10	ns

Switching Characteristics $V_{CC} = +5.0V \pm 10\%$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$ (Notes 3-6, 9)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
^t PHLD	Differential Propagation Delay High to Low	$R_{L} = 100\Omega, C_{L} = 5 \text{ pF}$ (<i>Figures 2</i> and <i>3</i>)	0.5	2.0	3.5	ns
^t PLHD	Differential Propagation Delay Low to High		0.5	2.1	3.5	ns
tskd tphld-tplhd	Differential Skew		0	80	900	ps
tsk1	Channel to Channel Skew	Note 4	0	0.3	1.0	ns
tSK2	Chip to Chip Skew	Note 5			3.0	ns
ттен	Rise Time	$R_L = 100\Omega, C_L = 5 pF$		0.35	2.0	ns
tthL	Fall Time	(<i>Figures 2</i> and <i>3</i>)		0.35	2.0	ns
t _{PHZ}	Disable Time High to Z	(<i>Figures 4</i> and <i>5</i>)		2.5	15	ns
t _{PLZ}	Disable Time Low to Z			2.5	15	ns
t _{PZH}	Enable Time Z to High			2.5	15	ns
t _{PZL}	Enable Time Z to Low			2.5	15	ns



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Applications Information

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as is shown in Figure 6. This configuration provides a clean signaling environment for the quick edge rates of the drivers. The receiver is connected to the driver through a balanced media which may be a standard twisted pair cable, a parallel pair cable, or simply PCB traces. Typically, the characteristic impedance of the media is in the range of 100Ω . A termination resistor of 100 Ω should be selected to match the media, and is located as close to the receiver input pins as possible. The termination resistor converts the current sourced by the driver into a voltage that is detected by the receiver. Other configurations are possible such as a multireceiver configuration, but the effects of a mid-stream connector(s), cable stub(s), and other impedance discontinuities as well as ground shifting, noise margin limits, and total termination loading must be taken into account.

The DS90C031 differential line driver is a balanced current source design. A current mode driver, generally speaking has a high output impedance and supplies a constant current for a range of loads (a voltage mode driver on the other hand supplies a constant voltage for a range of loads). Current is switched through the load in one direction to produce a logic state and in the other direction to produce the other logic state. The typical output current is mere 3.4 mA, a minimum of 2.5 mA, and a maximum of 4.5 mA. The current mode **requires** (as discussed above) that a resistive termination be employed to terminate the signal and to complete the loop as shown in *Figure 6*. AC or unterminated configurations are not allowed. The 3.4 mA loop current will de-

velop a differential voltage of 340 mV across the 100 Ω termination resistor which the receiver detects with a 240 mV minimum differential noise margin neglecting resistive line losses (driven signal minus receiver threshold (340 mV-100 mV = 240 mV)). The signal is centered around + 1.2V (Driver Offset, V_{OS}) with respect to ground as shown in *Figure 7*. Note that the steady-state voltage (V_{SS}) peak-to-peak swing is twice the differential voltage (V_{OD}) and is typically 680 mV.

The current mode driver provides substantial benefits over voltage mode drivers, such as an RS-422 driver. Its quiescent current remains relatively flat versus switching frequency. Whereas the RS-422 voltage mode driver increases exponentially in most case between 20 MHz–50 MHz. This is due to the overlap current that flows between the rails of the device when the internal gates switch. Whereas the current mode driver switches a fixed current between its output without any substantial overlap current. This is similar to some ECL and PECL devices, but without the heavy static I_{CC} requirements of the ECL/PECL designs. LVDS requires >80% less current than similar PECL devices. AC specifications for the driver are a tenfold improvement over other existing RS-422 drivers.

The TRI-STATE function allows the driver outputs to be disabled, thus obtaining an even lower power state when the transmission of data is not required.

The footprint of the DS90C031 is the same as the industry standard 26LS31 Quad Differential (RS-422) Driver.



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Pin Descriptions

Pin No.	Name	Description
1, 7, 9, 15	D _{IN}	Driver input pin, TTL/CMOS compatible
2, 6, 10, 14	D _{OUT} +	Non-inverting driver output pin, LVDS levels
3, 5, 11, 13	D _{OUT} -	Inverting driver output pin, LVDS levels
4	EN	Active high enable pin, OR-ed with EN*
12	EN*	Active low enable pin, OR-ed with EN
16	V _{CC}	Power supply pin, $+5V \pm 10\%$
8	GND	Ground pin

Ordering Information

Operating Temperature	Package Type/ Number	Order Number
-40°C to +85°C	SOP/M16A	DS90C031TM

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.

Note 2: Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground except: V_{OD1} and ΔV_{OD1}.

Note 3: All typicals are given for: $V_{CC} = +5.0V$, $T_A = +25^{\circ}C$.

Note 4: Channel to Channel Skew is defined as the difference between the propagation delay of the channel and the other channels in the same chip with an event on the inputs.

Note 5: Chip to Chip Skew is defined as the difference between the minimum and maximum specified differential propagation delays.

Note 6: Generator waveform for all tests unless otherwise specified: f = 1 MHz, $Z_0 = 50\Omega$, $t_f \le 6 \text{ ns}$, and $t_f \le 6 \text{ ns}$.

Note 7: ESD Ratings: HBM (1.5 k Ω , 100 pF) \geq 3,500V

 $\mathsf{EIAJ}\left(0\Omega,200\,\mathsf{pF}\right)\geq250\mathsf{V}$

Note 8: Output short circuit current (IOS) is specified as magnitude only, minus sign indicates direction only.

Note 9: CL includes probe and jig capacitance.



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Typical Performance Characteristics (Continued) **Differential Propagation Delay Differential Propagation Delay** Delay (ns) фLHD, tрнLD - Differential Propagation Delay (ns) vs Power Supply Voltage vs Ambient Temperature 4 4 $T_A = 25°C$ $v_{\rm CC} = 5v$ PLHD. PHLD - Differential Propagation Freq = 65 MHz Freq = 65 MHz Load = 100Ω Load = 100Ω 3 3 PHLD PLHD 2 2 ь t PHLD 1 1 0 0 4.75 4.5 5 5.25 5.5 -40 -15 10 35 60 85 T_A - Ambient Temperature (°C) V_{CC} - Power Supply Voltage (V) TL/F/11946-27 TL/F/11946-28 **Differential Skew vs Differential Skew vs Power Supply Voltage Amblent Temperature** 0.4 0.4 $T_A = 25^{\circ}C$ $v_{cc} = 5v$ Differential Skew (ns) Freq = 65 MHz - Differential Skew (ns) Freq = 65 MHz Load = 100Ω Load = 100Ω 0.3 0.3 0.2 0.2 1 0.1 0.1 SKD SKD 0 0 4.75 5 5.25 -15 10 35 60 4.5 5.5 -40 85 V_{CC} - Power Supply Voltage (V) T_A - Ambient Temperature (°C) TL/F/11946-29 TL/F/11946-30 **Differential Transition Time Differential Transition Time** vs Power Supply Voltage vs Ambient Temperature trLH+ trHL - Differential Transition Time (ns) - Differential Transition Time (ns) 0.5 0.5 T_A = 25°C $V_{\rm CC} = 5V$ Freq = 65 MHz Freq = 65 MHz 0.4 Load = 1002 0.4 Load = 1000 ^tTLH THL 0.3 0.3 t_{TLH} THL 0.2 0.2 0.1 0.1 tTHL 0 TLH. Ó 4.5 4.75 5 5.25 5.5 -40 -15 10 35 60 85 V_{CC} - Power Supply Voltage (V) T_A - Ambient Temperature (°C) TL/F/11946-31 TL/F/11946-32